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In re the Application of: MURAYAMA, Kei, et al

Group Art Unit: 2811

Serial No.: 10/709,096

Examiner: Junghwa M. IM

Filed: April 13, 2004

P.T.O. Confirmation No.: 3095

For: WIRING SUBSTRATE AND ELECTRONIC PARTS PACKAGING STRUCTURE

## **AMENDMENT UNDER 37 CFR §1.111**

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

March 29, 2006

Sir:

In response to the Office Action dated **January 25, 2006**, please amend the above-identified application as follows:

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this paper.

Remarks/Arguments begin on page 6 of this paper.